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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	33MHz
Connectivity	EBI/EMI, UART/USART
Peripherals	-
Number of I/O	24
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	236 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z86c9333fsg

GENERAL DESCRIPTION (Continued)

There are 256 registers located on-chip and organized as 236 general-purpose registers, 16 control and status registers, and four I/O port registers. The register file can be divided into sixteen groups of 16 working registers each. Configuration of the registers in this manner allows the use of short format instructions; in addition, any of the individual registers can be accessed directly. There are an additional 17 registers implemented in the Expanded Register File in Banks D and E. Two of the registers may be used as general-purpose registers, while 15 registers supply the data and control functions for the Multiply/Divide Unit and Counter/Timer blocks.

Notes:

All Signals with a preceding front slash, "/", are active Low, e.g.: B//W (WORD is active Low); /B/W (BYTE is active Low, only).

Power connections follow conventional descriptions below:

Connection	Circuit	Device
Power Ground	V_{CC} GND	V_{DD} V_{SS}

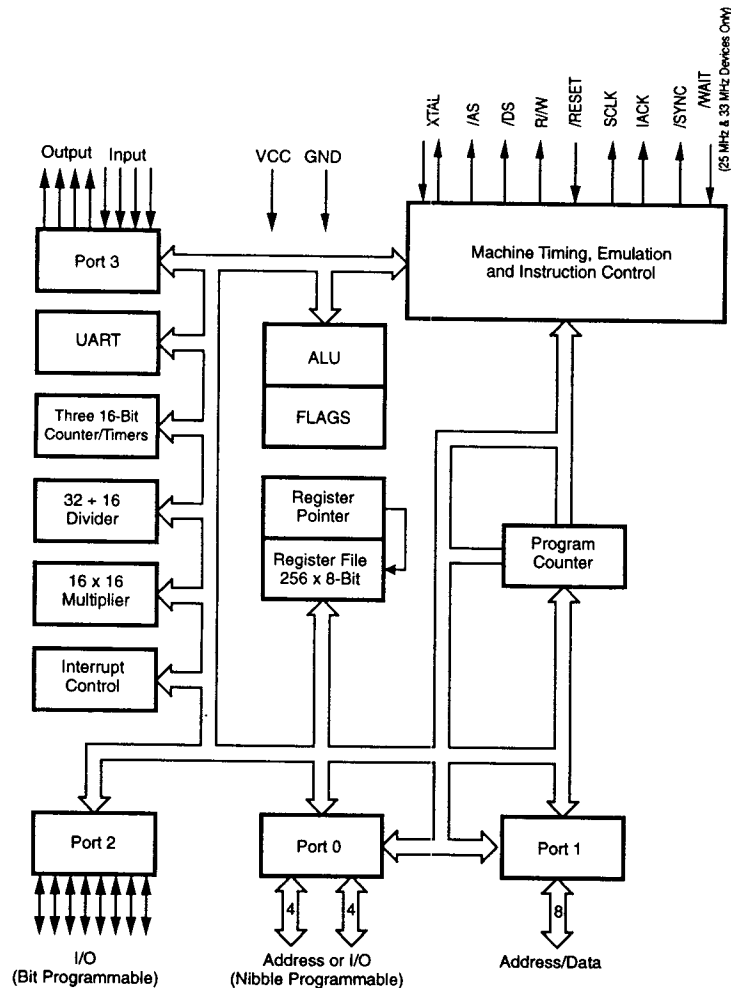


Figure 1. Functional Block Diagram

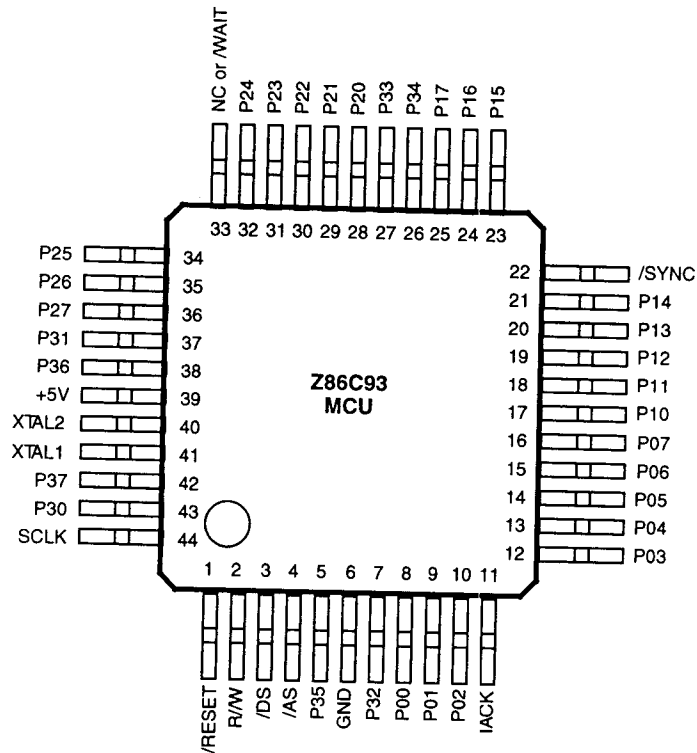


Figure 5. 44-Pin QFP

Table 3. 44-Pin QFP Pin Identification

No	Symbol	Function	Direction	No	Symbol	Function	Direction
1	/RESET	Reset	Input	26	P34	Port 3 pin 4	Output
2	R/W	Read/Write	Output	27	P33	Port 3 pin 3	Input
3	/DS	Data Strobe	Output	28-32	P20-P24	Port 2 pin 0,1,2,3,4	In/Output
4	/AS	Address Strobe	Output	33	N/C	Not Connected (20 MHz)	Input
5	P35	Port 3 pin 5	Input		/WAIT	WAIT (25 or 33 MHz)	Input
6	GND	Ground GND	Input	34-36	P25-P27	Port 2 pin 5,6,7	In/Output
7	P32	Port 3 pin 2	Input	37	P31	Port 3 pin 1	Input
8-10	P00-P02	Port 0 pin 0,1,2	In/Output	38	P36	Port 3 pin 6	Output
11	IACK	Int. Acknowledge	Output	39	V _{cc}	Power Supply	Input
12-16	P03-P07	Port 0 pin 3,4,5,6,7	In/Output	40	XTAL2	Crystal, Osc. Clock	Output
17-21	P10-P14	Port 1 pin 0,1,2,3,4	In/Output	41	XTAL1	Crystal, Osc. Clock	Input
22	/SYNC	Synchronize Pin	Output	42	P37	Port 3 pin 7	Output
23-25	P15-P17	Port 1 pin 5,6,7	In/Output	43	P30	Port 3 pin 0	Input
				44	SCLK	System Clock	Output

PIN FUNCTIONS (Continued)

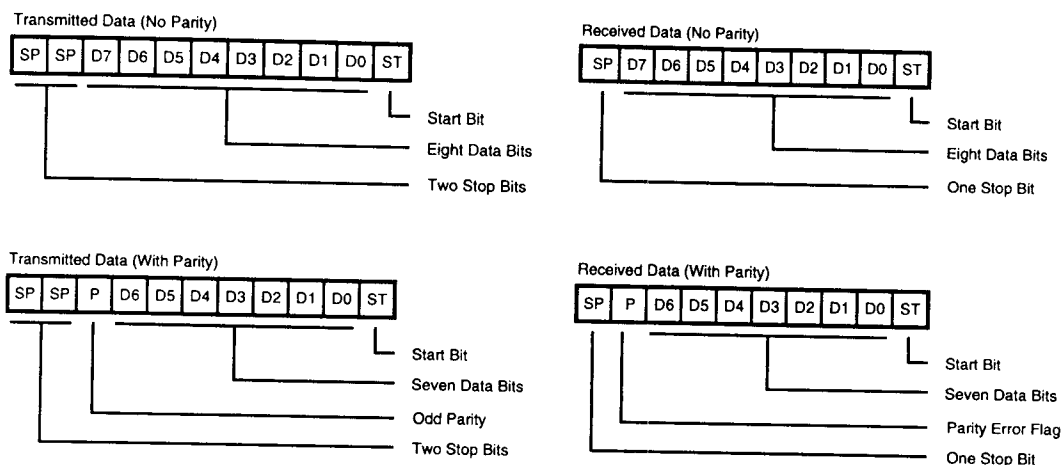


Figure 11. Serial Data Formats

ADDRESS SPACE

Program Memory. The Z86C93 can address up to 64 Kbytes of external program memory. Program execution begins at external location 000CH after a reset.

Data Memory. The Z96C93 can address up to 64 Kbytes of external data memory. External data memory is included with, or separated from, the external program memory

space. /DM, an optional I/O function that can be programmed to appear on pin P34 is used to distinguish between data and program memory space (Figure 12). The state of the /DM signal is controlled by the type instruction being executed. An LDC opcode references PROGRAM (/DM inactive) memory, and an LDE instruction references DATA (/DM active Low) memory.

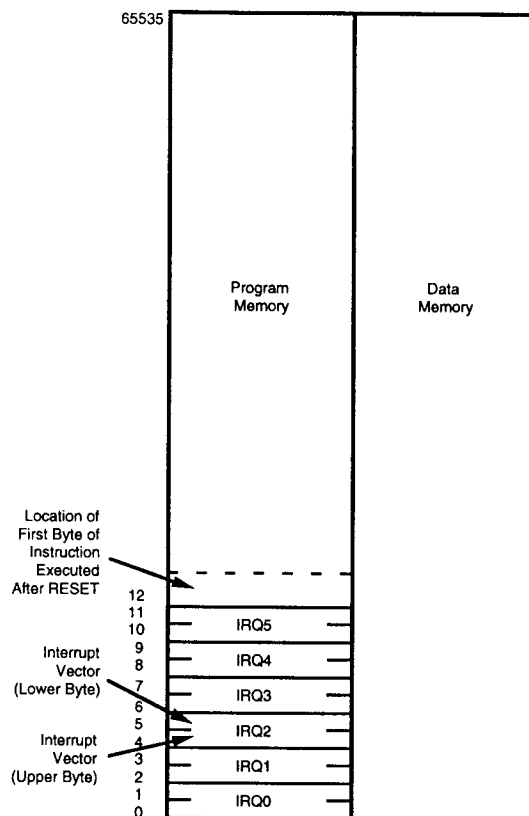


Figure 12. Program and Data Memory Configuration

Expanded Register File. The register file has been expanded to allow for additional system control registers, and for mapping of additional peripheral devices along with I/O ports into the register address area (Figure 13). The Z8 register address space R0 through R15 has now been implemented as 16 groups of 16 registers per group. These register groups are known as the ERF (Expanded Register File). Bits 7-4 of register RP select the working register group. Bits 3-0 of register RP select the expanded register group (Figure 14). The registers that are used in the multiply/divide unit reside in the Expanded Register File at Bank E and those for the additional timer control words reside in Bank D. The rest of the Expanded Register is not physically implemented and is open for future expansion.

Register File. The Register File consists of four I/O port registers, 236 general-purpose registers and 16 control

and status registers. The instructions can access registers directly or indirectly via an 8-bit address field. The Z86C93 also allows short 4-bit register addressing using the Register Pointer (Figure 15). In the 4-bit mode, the Register File is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working-register group.

Note: Register Group E0-EF can only be accessed through working registers and indirect addressing modes.

Stack. The Z86C93 has a 16-bit Stack Pointer (R254-R255), used for external stack, that resides anywhere in the data memory. An 8-bit Stack Pointer (R255) is used for the internal stack that resides within the 236 general-purpose registers (R4-R239). The high byte of the Stack Pointer (SPH, Bits 8-15) can be used as a general-purpose register when using internal stack only.

Register allocation. The following is the register allocation during multiplication.

Multiplier high byte	MREG2
Multiplier low byte	MREG3
Multiplicand high byte	MREG4
Multiplicand low byte	MREG5
Result high byte of high word	MREG0
Result low byte of high word	MREG1
Result high byte of low word	MREG2
Result low byte of low word	MREG3
Multiply/Divide Control register	MDCON

The following is the register allocation during division.

High byte of high word of dividend	MREG0
Low byte of high word of dividend	MREG1
High byte of low word of dividend	MREG2
Low byte of low word of dividend	MREG3
High byte of divisor	MREG4
Low byte of divisor	MREG5
High byte of remainder	MREG0
Low byte of remainder	MREG1
High byte of quotient	MREG2
Low byte of quotient	MREG3
Multiply/Divide Control register	MDCON

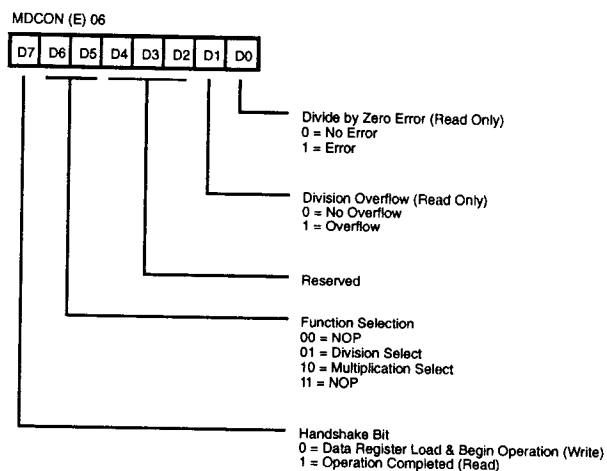


Figure 17. Multiply/Divide Control Register (MDCON)

Control register. The MDCON (Multiply/Divide Control Register) is used to interface with the multiply/divide unit (Figure 16). Specific functions of various bits in the control register are given below.

DONE bit (D7). This bit is a handshake bit between the math unit and the external world. On power up, this bit is set to 1 to indicate that the math unit has completed the previous operation and is ready to perform the next operation.

Before starting a new multiply/divide operation, this bit should be reset to 0 by the processor/programmer. This indicates that all the data registers have been loaded and the math unit can now begin a multiply/divide operation. During the process of multiplication or division, this bit is write-protected. Once the math unit completes its operation it sets this bit to indicate the completion of operation. The processor/programmer can then read the result.

MULSL. Multiply Select (D6). If this bit is set to 1, it indicates a multiply operation directive. Like the DONE bit, this bit is also write-protected during math unit operation and is reset to 0 by the math unit upon starting of the multiply/divide operation.

DIVSL. Division Select (D5). Similar to D6, D5 starts a division operation.

D4-D2. Reserved.

DIVOVF. Division Overflow (D1). This bit indicates an overflow during the division process. Division overflow occurs when the high word of the dividend is greater than or equal to the divisor. This bit is read only. When set to 1, it indicates overflow error.

The counters are programmed to start, stop, restart to continue, or restart from the initial value. The counters can also be programmed to stop upon reaching zero (single pass mode) or to automatically reload the initial value and continue counting (modulo-n continuous mode).

The counters, but not the prescalers, are read at any time without disturbing their value or count mode. The clock source for T1 is user-definable and is either the internal microprocessor clock divided by four, or an external signal input via Port 3. The Timer Mode register configures the external timer input (P31) as an external clock, a trigger input that is retriggerable or non-retriggerable, or as a gate input for the internal clock. The counter/timers are cascaded by connecting the T0 output to the input of T1. Either T0 or T1 can be outputted via P36.

The following are the enhancements made to the counter/timer block on the Z86C93 (Figure 18):

- T0 counter length is extended to 16 bits. For example, T0 now has a 6-bit prescaler and 16-bit down counter.
- T1 counter length is extended to 16 bits. For example, T1 now has a 6-bit prescaler and 16-bit down counter.
- A new counter/timer T2 is added. T2 has a 4-bit prescaler and a 16-bit down counter with capture register.

These three counters are cascadable as shown in Table 6. The result is that T2 may be extendable to 32 bits and T1 extendable to 24 bits. Bits 1 and 0 (CAS1 AND CAS0) of the T2 Prescaler Register (PRE2) determine the counter length.

Table 6. Counter Length Configurations

CAS 1	CAS0	T0	T1	T2
0	0	8	8	32
0	1	16	16	16
1	0	8	24	16
1	1	8	16	24

The controlling clock input to T2 is programmed to XTAL/2 or XTAL/8 (only when T2 counter length is 16 bits), which results in a resolution of 100 ns at an external XTAL clock speed of 20 MHz.

Capture Register. T2 has a 16-bit capture register associated with T2 HIGH BYTE and T2 LOW BYTE registers. The negative going transition on pin P33 enables the latching of the current T2 value (16 bits) into the capture register. The register mapping of the capture register is in Bank D (Figure 13). Note that the negative transition on P33 is capable of generating an interrupt. Also, the negative transition on P33 always latches the current T2 value into the capture register. There is no need for a control bit to enable/disable the latching; the capture register is read only.

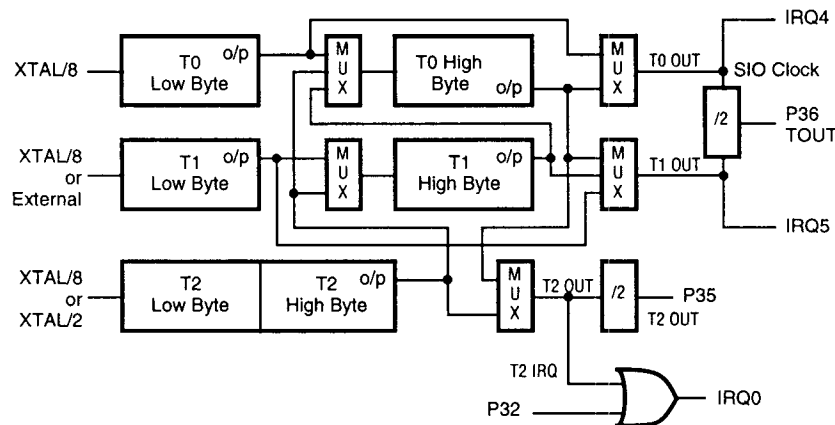


Figure 18. Counter/Timer Block Diagram

FUNCTIONAL DESCRIPTION (Continued)

Operation

Except for the programmable down counter length and clock input, T2 is identical to T0.

T0 and T1 retain all their features except that now they are extendable interims of the down-counter length.

The output of T2, under program control, goes to an output pin (P35). Also, the interrupt generated by T2 is ORed with the interrupt request generated by P32. Note that the service routine then has to poll the T2 flag bit and also clear it (Bit 7 of T2 Timer Mode Register).

On power up, T0 and T1 are configured in the 8-bit down counter length mode (to be compatible with Z86C91) and T2 is in the 32-bit mode with its output disabled (no interrupt is generated and T2 output DOES NOT go to port pin P35).

The UART uses T0 for generating the bit clock. This means, while using UART, T0 should be in 8-bit mode. So, while using the UART there are only two independent timer/counters.

The counters are configured in the following manner:

Timer	Mode	Byte
T0	8-bit	Low Byte (T0)
T0	16-bit	High Byte (T0) + Low Byte (T0)
T1	8-bit	Low Byte (T1)
T1	16-bit	High Byte (T1) + Low Byte (T1)
T1	24-bit	High Byte (T0) + High Byte (T1) + Low Byte (T1)
T2	16-bit	High Byte (T2) + Low Byte (T2)
T2	24-bit	High Byte (T0) + High Byte (T2) + Low Byte (T2)
T2	32-bit	High Byte (T0) + High Byte (T1) + High Byte (T2) + Low Byte (T2)

Note that the T2 interrupt is logically ORed with P32 to generate IRQ0.

The T2 Timer Mode register is shown in Figure 19. Upon reaching end of count, bit 7 of this register is set to one. This bit IS NOT reset in hardware and it has to be cleared by the interrupt service routine.

T2 interrogates the state of the Count Mode Bit (D2) once it has counted down to its zero value. T2 then makes the decision to continue counting (Module N Mode) or stop (Single Pass Mode). Observe this functionality if attempting to modify the count mode prior to the end of count bit (D7) being set.

The register map of the new CTC registers is shown in Figure 13. T0 high byte and T1 high byte are at the same relative locations as their respective low bytes, but in a different register bank.

The T2 prescaler register is shown in Figure 19. Bits 1 and 0 of this register control the various cascade modes of the counters.

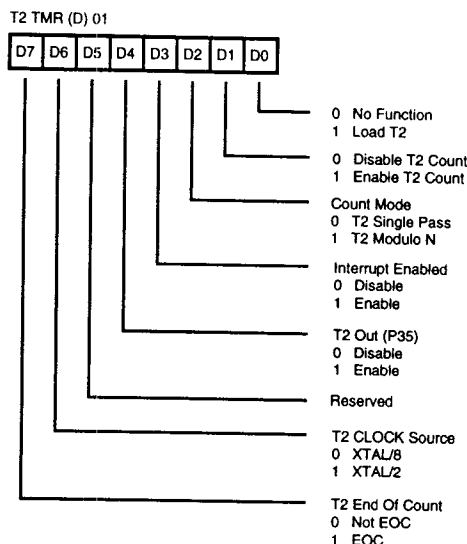


Figure 19. T2 Timer Mode Register (T2)

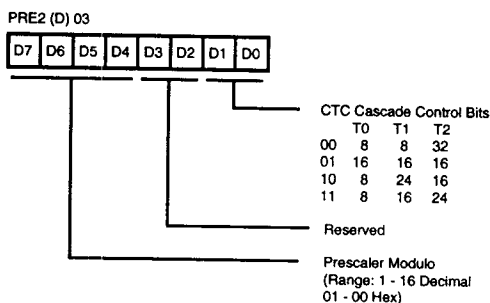


Figure 20. T2 Prescaler Register (PRE2)

DC ELECTRICAL CHARACTERISTICS

$$V_{CC} = 3.3V \pm 10\%$$

Sym	Parameter	$T_A = 0^{\circ}\text{C to } +70^{\circ}\text{C}$		Typical at 25°C	Units	Conditions
		Min	Max			
	Max Input Voltage		7		V	$I_{IN} = 250 \mu\text{A}$
V_{CH}	Clock Input High Voltage	$0.8 V_{CC}$	V_{CC}		V	Driven by External Clock Generator
V_{CL}	Clock Input Low Voltage	-0.03	$0.1 \times V_{CC}$		V	Driven by External Clock Generator
V_{IH}	Input High Voltage	$0.7 \times V_{CC}$	V_{CC}		V	
V_{IL}	Input Low Voltage	-0.3	$0.1 \times V_{CC}$		V	
V_{OH}	Output High Voltage	1.8			V	$I_{OH} = -1.0 \text{ mA}$
V_{OHI}	Output High Voltage	$V_{CC} - 100\text{mV}$			V	$I_{OH} = -100 \mu\text{A}$
V_{OL}	Output Low Voltage		0.4		V	$I_{OL} = +1.0 \text{ mA}$
V_{RH}	Reset Input High Voltage	$0.8 \times V_{CC}$	V_{CC}		V	
V_{RI}	Reset Input Low Voltage	-0.03	$0.1 \times V_{CC}$		V	
I_{IL}	Input Leakage	-2	2		μA	Test at 0V, V_{CC}
I_{OL}	Output Leakage	-2	2		μA	Test at 0V, V_{CC}
I_{IR}	Reset Input Current		-80		μA	$V_{RI} = 0\text{V}$
I_{CC}	Supply Current		30	20	mA	@ 25 MHz [1]
I_{CC1}	Stand By Current (HALT Mode)		12	8	mA	HALT Mode $V_{IN} = 0\text{V}$, V_{CC} @ 25 MHz [1]
I_{CC2}	Stand By Current (HALT Mode)		8	1	μA	STOP Mode $V_{IN} = 0\text{V}$, V_{CC} [1]
I_{AL}	Auto Latch Low Current	-10	10	5	μA	

Note:

[1] All inputs driven to 0V, V_{CC} and outputs floating.

AC CHARACTERISTICS

External I/O or Memory Read/Write Timing Diagram

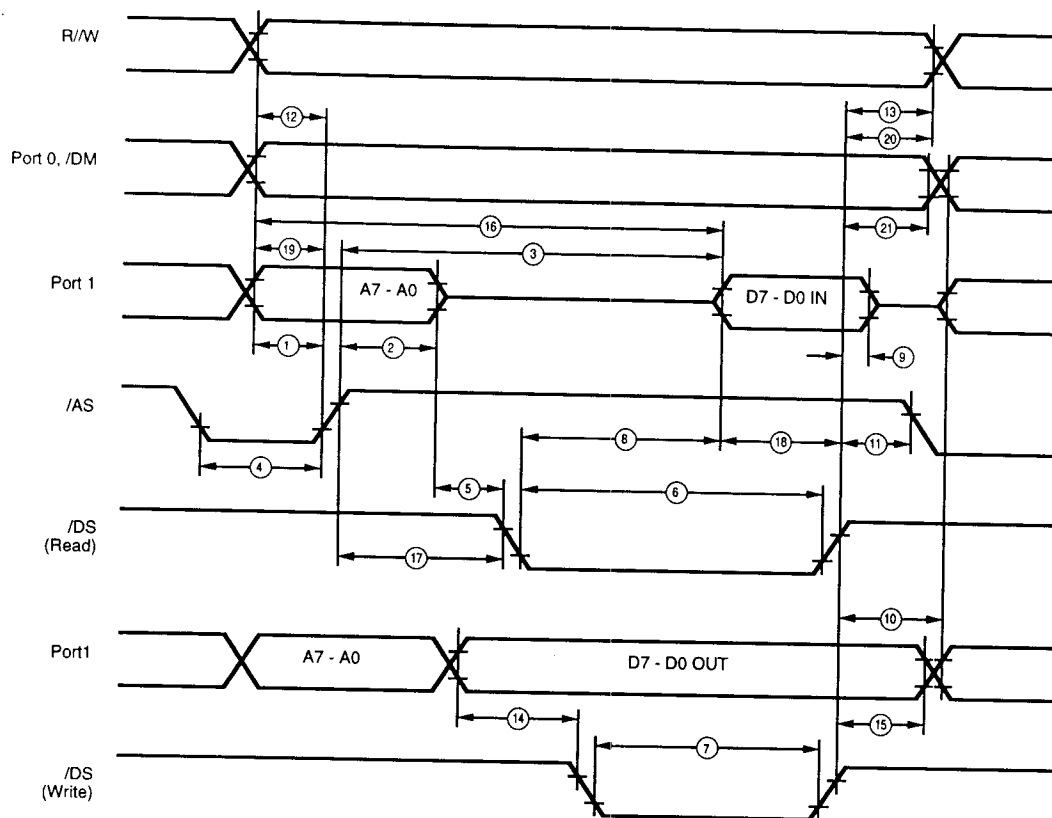


Figure 24. External I/O or Memory Read/Write Timing

AC CHARACTERISTICS

External I/O or Memory Read and Write; DSR/DSW; WAIT Timing Table

			T _A = 0°C to +70°C						Typical V _{cc} =5.0V @ 25°C	Units
No	Sym	Parameter	33 MHz		25 MHz		20 MHz			
			Min	Max	Min	Max	Min	Max		
1	TdA(AS)	Address Valid To /AS Rise Delay	13		22		26			ns
2	TdAS(A)	/AS Rise To Address Hold Time	20		25		28			ns
3	TdAS(DI)	/AS Rise Data In Req'd Valid Delay		90		130		160		ns
4	TwAS	/AS Low Width	20		28		36			ns
5	TdAZ(DSR)	Address Float To /DS (Read)	0		0		0			ns
6	TwDSR	/DS (Read) Low Width	65		100		130			ns
7	TwDSW	/DS (Write) Low Width	40		65		75			ns
8	TdDSR(DI)	/DS (Read) To Data in Req'd Valid Delay		30		78		100		ns
9	ThDSR(DI)	/DS Rise (Read) to Data In Hold Time	0		0		0			ns
10	TdDS(A)	/DS Rise To Address Active Delay	25		34		40			ns
11	TdDS(AS)	/DS Rise To /AS Delay	16		30		36			ns
12	TdR/W(AS)	R/W To /AS Rise Delay	12		26		32			ns
13	TdDS(R/W)	/DS Rise To R/W Valid Delay	12		30		36			ns
14	TdDO(DSW)	Data Out To /DS (Write) Delay	12		34		40			ns
15	ThDSW(DO)	/DS Rise (Write) To Data Out Hold Time	12		34		40			ns
16	TdA(DI)	Address To Data In Req'd Valid Delay		110		160		200		ns
17	TdAS(DSR)	/AS Rise To /DS (Read) Delay	20		40		48			ns
18	TaDI(DSR)	Data In Set-up Time To /DS Rise Read	16		30		36			ns
19	TdDM(AS)	/DM To /AS Rise Delay	10		22		26			ns
20	TdDS(DM)	/DS Rise To /DM Valid Delay							34*	ns
21	ThDS(A)	/DS Rise To Address Valid Hold Time							34*	ns
22	TdXT(SCR)	XTAL Falling to SCLK Rising							20*	ns
23	TdXT(SCF)	XTAL Falling to SCLK Falling							23*	ns
24	TdXT(DSRF)	XTAL Falling to/DS Read Falling							29*	ns
25	TdXT(DSRR)	XTAL Falling to /DS Read Rising							29*	ns
26	TdXT(DSWF)	XTAL Falling to /DS Write Falling							29*	ns
27	TdXT(DSWF)	XTAL Falling to /DS Write Rising							29*	ns
28	TsW(XT)	Wait Set-up Time							10*	ns
29	ThW(XT)	Wait Hold Time							15*	ns
30	TwW	Wait Width (One Wait Time)							25*	ns

Notes:

When using extended memory timing add 2 TpC.

Timing numbers given are for minimum TpC.

* Preliminary value to be characterized.

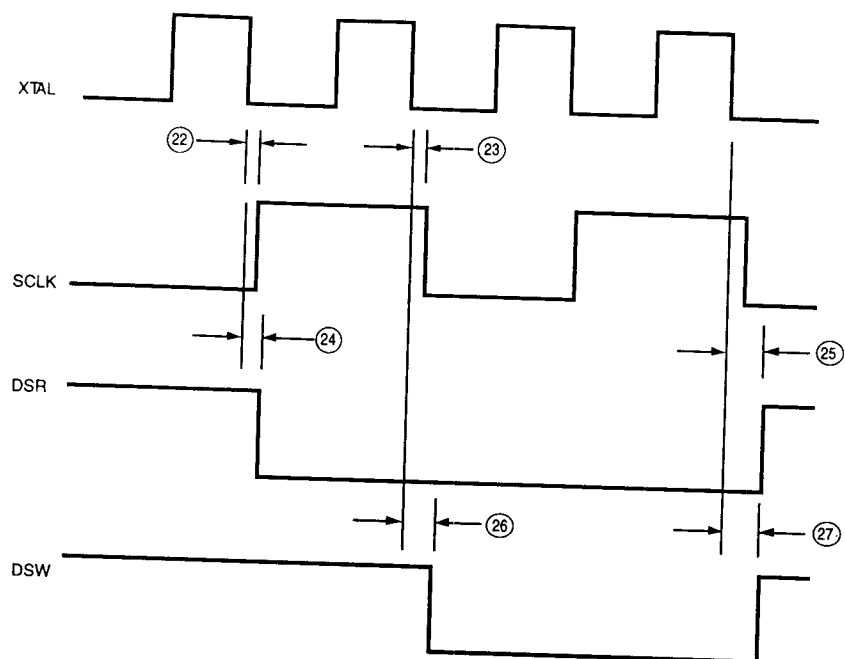


Figure 25. XTAL/SCLK To DSR and DSW Timing

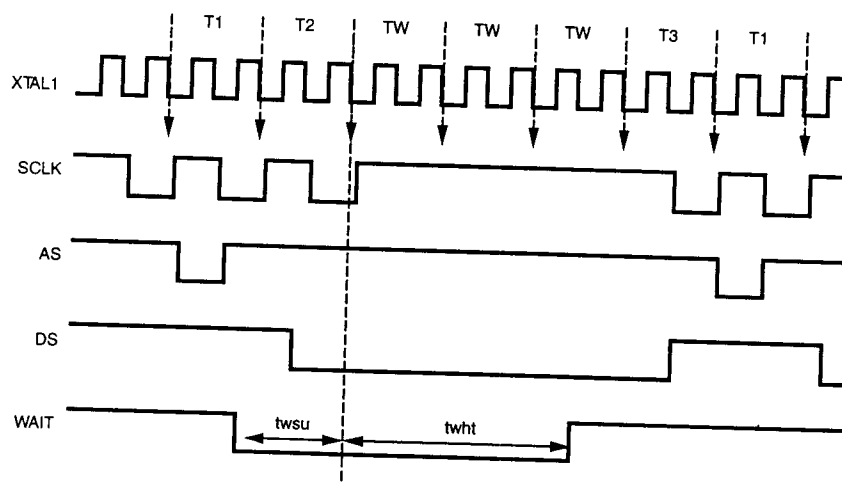


Figure 26. XTAL/SCLK To WAIT Timing
(25 MHz Device Only)

AC CHARACTERISTICS

Handshake Timing Diagrams

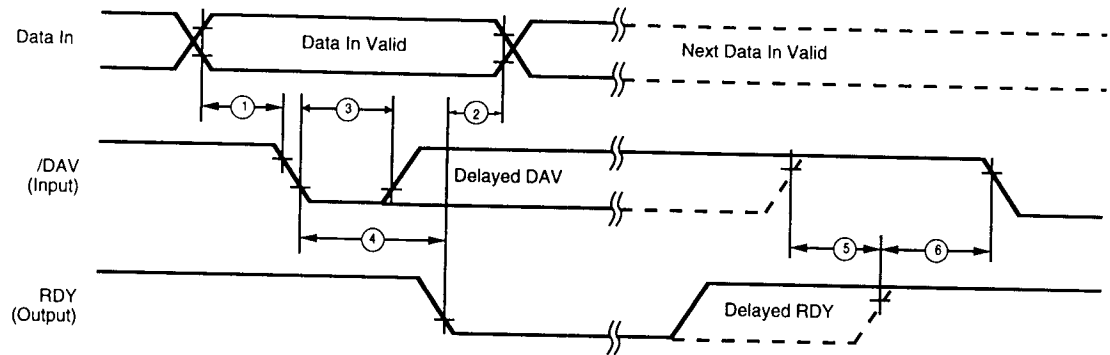


Figure 28. Input Handshake Timing

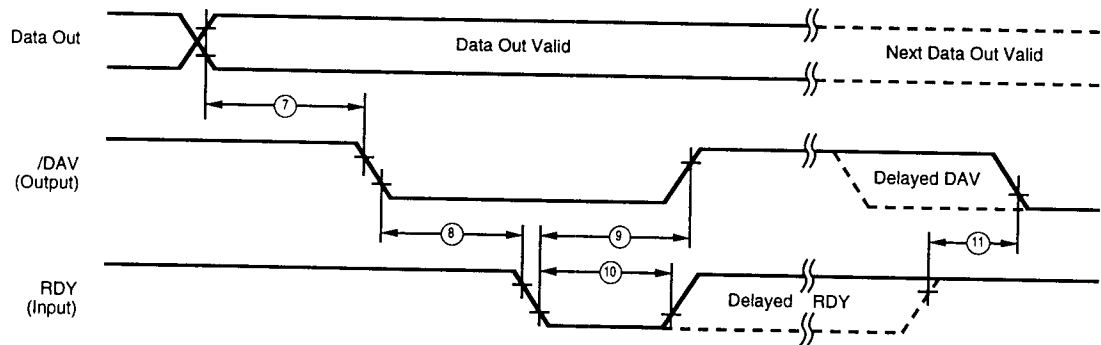


Figure 29. Output Handshake Timing

Z8 CONTROL REGISTERS

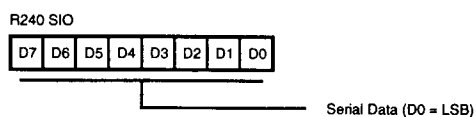


Figure 37. Serial I/O Register
(F0H: Read/Write)

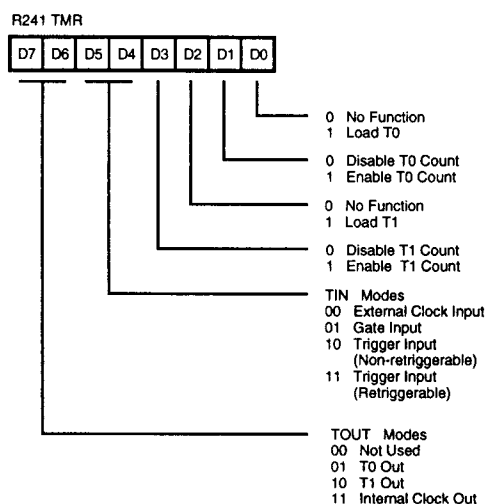


Figure 38. Timer Mode Register
(F1H: Read/Write)

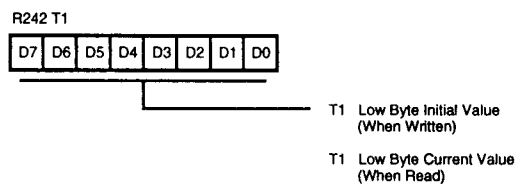


Figure 39. Counter/Timer 1 Register
(F2H: Read/Write)

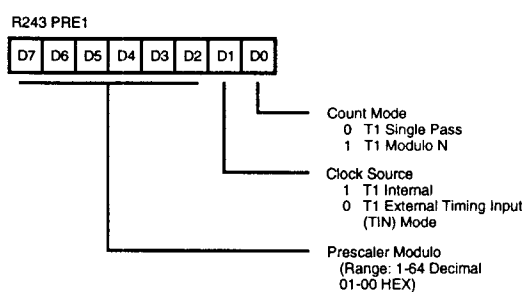


Figure 40. Prescaler 1 Register
(F3H: Write Only)

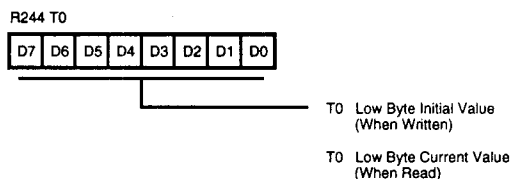


Figure 41. Counter/Timer 0 Register
(F4H: Read/Write)

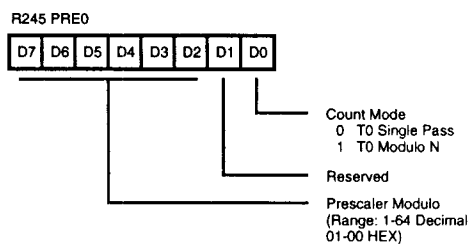


Figure 42. Prescaler 0 Register
(F5H: Write Only)

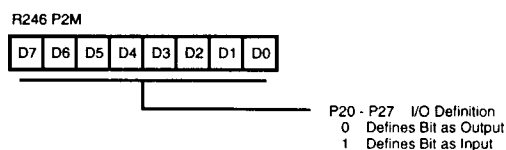


Figure 43. Port 2 Mode Register
(F6H: Write Only)

Z8 CONTROL REGISTERS (Continued)

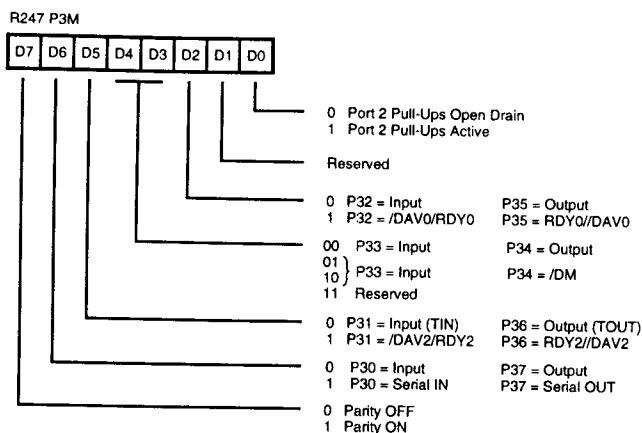


Figure 44. Port 3 Mode Register
(F7H: Write Only)

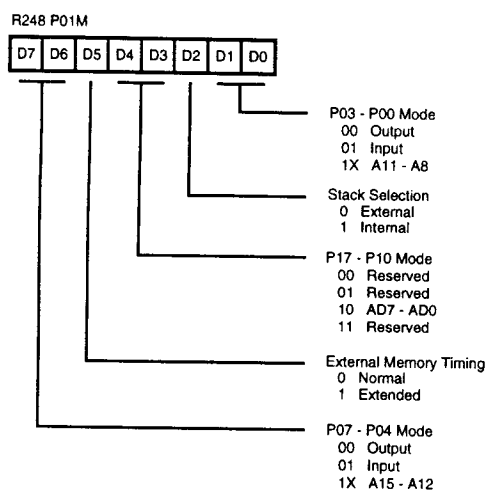


Figure 45. Ports 0 and 1 Mode Registers
(F8H: Write Only)

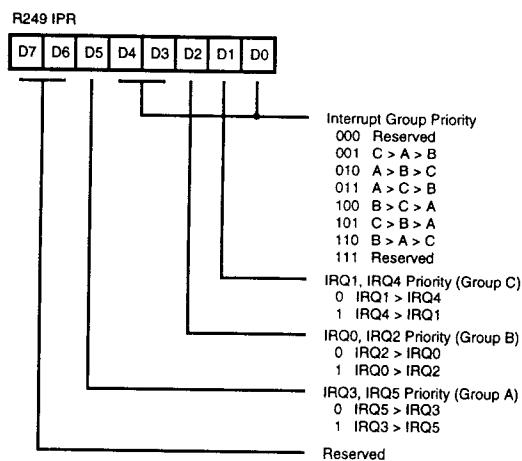


Figure 46. Interrupt Priority Register
(F9H: Write Only)

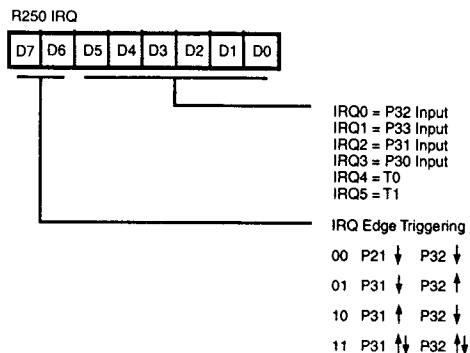


Figure 47. Interrupt Request Register (FAH: Read/Write)

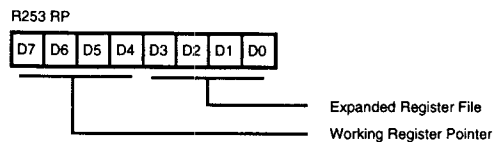


Figure 50. Register Pointer (FDH: Read/Write)

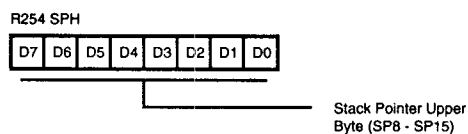


Figure 51. Stack Pointer High (FEH: Read/Write)

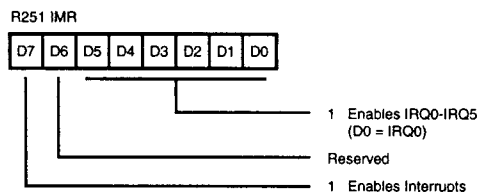


Figure 48. Interrupt Mask Register (FBH: Read/Write)

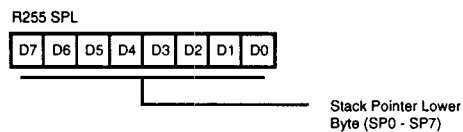


Figure 52. Stack Pointer Low (FFH: Read/Write)

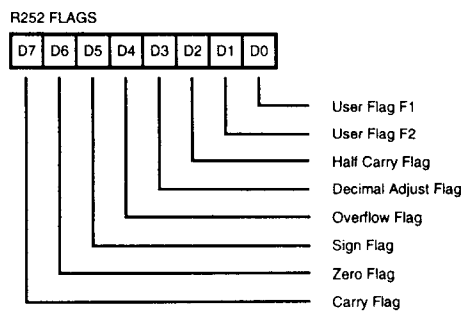
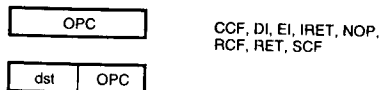
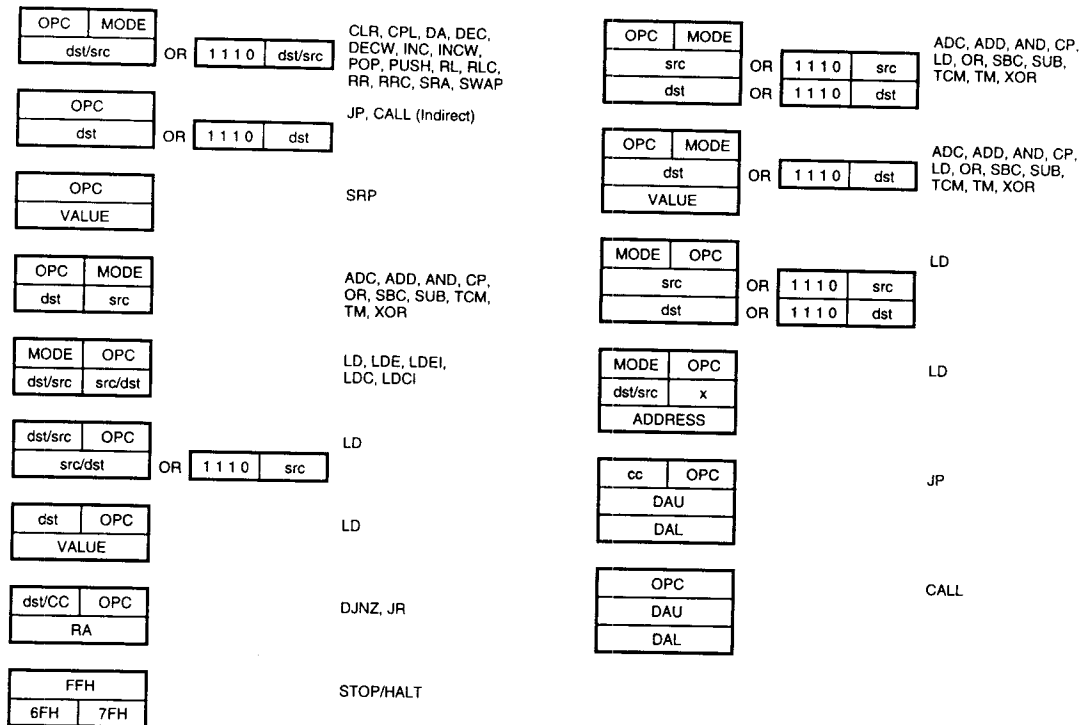


Figure 49. Flag Register (FCH: Read/Write)

INSTRUCTION FORMATS



One-Byte Instructions



Two-Byte Instructions

Three-Byte Instructions

INSTRUCTION SUMMARY

Note: Assignment of a value is indicated by the symbol " \leftarrow ". For example:

$$\text{dst} \leftarrow \text{dst} + \text{src}$$

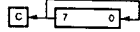
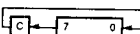
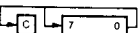
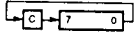
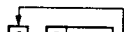
indicates that the source data is added to the destination data and the result is stored in the destination location. The

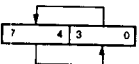
notation "addr (n)" is used to refer to bit (n) of a given operand location. For example:

$$\text{dst} (7)$$

refers to bit 7 of the destination operand.

INSTRUCTION SUMMARY (Continued)

Instruction and Operation	Address Mode		Opcode Byte (Hex)	Flags Affected						
	dst	src		C	Z	S	V	D	H	
NOP			FF	-	-	-	-	-	-	-
OR dst, src dst ← dst OR src	†		4[]	-	*	*	0	-	-	-
POP dst dst ← @SP; SP ← SP + 1	R		50	-	-	-	-	-	-	-
	IR		51	-	-	-	-	-	-	-
PUSH src SP ← SP - 1; @SP ← src	R		70	-	-	-	-	-	-	-
	IR		71	-	-	-	-	-	-	-
RCF C ← 0			CF	0	-	-	-	-	-	-
RET PC ← @SP; SP ← SP + 2			AF	-	-	-	-	-	-	-
RL dst 	R		90	*	*	*	*	-	-	-
	IR		91	*	*	*	*	-	-	-
RLC dst 	R		10	*	*	*	*	-	-	-
	IR		11	*	*	*	*	-	-	-
RRC dst 	R		E0	*	*	*	*	-	-	-
	IR		E1	*	*	*	*	-	-	-
RRC dst 	R		C0	*	*	*	*	-	-	-
	IR		C1	*	*	*	*	-	-	-
SBC dst, src dst ← dst ← src ← C	†		3[]	*	*	*	*	1	*	*
SCF C ← 1			DF	1	-	-	-	-	-	-
SRA dst 	R		D0	*	*	*	0	-	-	-
	IR		D1	*	*	*	0	-	-	-
SRP src RP ← src		Im	31	-	-	-	-	-	-	-

Instruction and Operation	Address Mode		Opcode Byte (Hex)	Flags Affected						
	dst	src		C	Z	S	V	D	H	
STOP			6F	-	-	-	-	-	-	-
SUB dst, src dst ← dst ← src	†		2[]	*	*	*	*	1	*	*
SWAP dst 	R		F0	X	*	*	X	-	-	-
	IR		F1	X	*	*	X	-	-	-
TCM dst, src (NOT dst) AND src	†		6[]	-	*	*	0	-	-	-
TM dst, src dst AND src	†		7[]	-	*	*	0	-	-	-
XOR dst, src dst ← dst XOR src	†		B[]	-	*	*	0	-	-	-

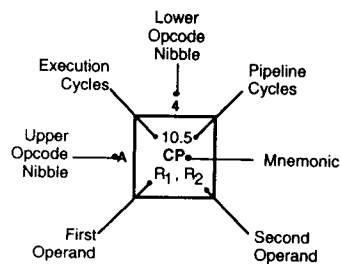
† These instructions have an identical set of addressing modes, which are encoded for brevity. The first opcode nibble is found in the instruction set table above. The second nibble is expressed symbolically by a '[]' in this table, and its value is found in the following table to the left of the applicable addressing mode pair.

For example, the opcode of an ADC instruction using the addressing modes r (destination) and Ir (source) is 13.

Address Mode		Lower Opcode Nibble
dst	src	
r	r	[2]
r	Ir	[3]
R	R	[4]
R	IR	[5]
R	IM	[6]
IR	IM	[7]

OPCODE MAP

		Lower Nibble (Hex)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Upper Nibble (Hex)	0	6.5 DEC R1	6.5 DEC IR1	6.5 ADD r1, r2	6.5 ADD r1, Ir2	10.5 ADD R2, R1	10.5 ADD IR2, R1	10.5 ADD R1, IM	10.5 ADD IR1, IM	6.5 LD r1, R2	6.5 LD r2, R1	12/10.5 DJNZ r1, RA	12/10.0 JR cc, RA	6.5 LD r1, IM	12.10.0 JP cc, DA	6.5 INC r1	
	1	6.5 RLC R1	6.5 RLC IR1	6.5 ADC r1, r2	6.5 ADC r1, Ir2	10.5 ADC R2, R1	10.5 ADC IR2, R1	10.5 ADC R1, IM	10.5 ADC IR1, IM								
	2	6.5 INC R1	6.5 INC IR1	6.5 SUB r1, r2	6.5 SUB r1, Ir2	10.5 SUB R2, R1	10.5 SUB IR2, R1	10.5 SUB R1, IM	10.5 SUB IR1, IM								
	3	8.0 JP IRR1	6.1 SRP IM	6.5 SBC r1, r2	6.5 SBC r1, Ir2	10.5 SBC R2, R1	10.5 SBC IR2, R1	10.5 SBC R1, IM	10.5 SBC IR1, IM								
	4	8.5 DA R1	8.5 DA IR1	6.5 OR r1, r2	6.5 OR r1, Ir2	10.5 OR R2, R1	10.5 OR IR2, R1	10.5 OR R1, IM	10.5 OR IR1, IM								
	5	10.5 POP R1	10.5 POP IR1	6.5 AND r1, r2	6.5 AND r1, Ir2	10.5 AND R2, R1	10.5 AND IR2, R1	10.5 AND R1, IM	10.5 AND IR1, IM								
	6	6.5 COM R1	6.5 COM IR1	6.5 TCM r1, r2	6.5 TCM r1, Ir2	10.5 TCM R2, R1	10.5 TCM IR2, R1	10.5 TCM R1, IM	10.5 TCM IR1, IM								6.0 STOP
	7	10/12.1 PUSH R2	12/14.1 PUSH IR2	6.5 TM r1, r2	6.5 TM r1, Ir2	10.5 TM R2, R1	10.5 TM IR2, R1	10.5 TM R1, IM	10.5 TM IR1, IM								7.0 HALT
	8	10.5 DECW RR1	10.5 DECW IR1	12.0 LDE r1, Ir2	18.0 LDEI Ir1, Ir2												6.1 DI
	9	6.5 RL R1	6.5 RL IR1	12.0 LDE r2, Ir1	18.0 LDEI Ir2, Ir1												6.1 EI
	A	10.5 INCW RR1	10.5 INCW IR1	6.5 CP r1, r2	6.5 CP r1, Ir2	10.5 CP R2, R1	10.5 CP IR2, R1	10.5 CP R1, IM	10.5 CP IR1, IM								14.0 RET
	B	6.5 CLR R1	6.5 CLR IR1	6.5 XOR r1, r2	6.5 XOR r1, Ir2	10.5 XOR R2, R1	10.5 XOR IR2, R1	10.5 XOR R1, IM	10.5 XOR IR1, IM								16.0 IRET
	C	6.5 RRC R1	6.5 RRC IR1	12.0 LDC r1, Ir2	18.0 LDCI Ir1, Ir2				10.5 LD r1, x, R2								6.5 RCF
	D	6.5 SRA R1	6.5 SRA IR1	12.0 LDC r2, Ir1	18.0 LDCI Ir2, Ir1	20.0 CALL* IRR1		20.0 CALL DA	10.5 LD r2, x, R1								6.5 SCF
	E	6.5 RR R1	6.5 RR IR1		6.5 LD r1, Ir2	10.5 LD R2, R1	10.5 LD IR2, R1	10.5 LD R1, IM	10.5 LD IR1, IM								6.5 CCF
	F	8.5 SWAP R1	8.5 SWAP IR1		6.5 LD Ir1, r2		10.5 LD R2, IR1										6.0 NOP



Legend:
R = 8-bit address
r = 4-bit address
R₁ or r₂ = Dst address
R₁ or r₂ = Src address

Sequence:
Opcode, First Operand,
Second Operand

Note: The blank areas are not defined.

* 2-byte instruction appears
as a 3-byte instruction

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